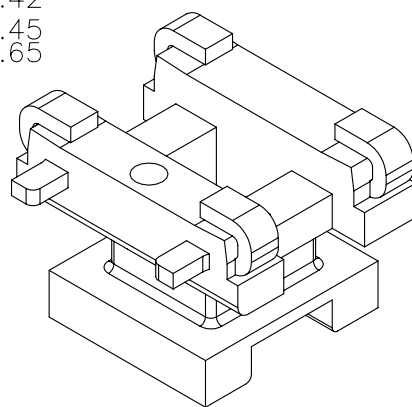
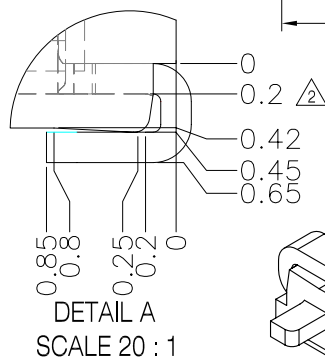
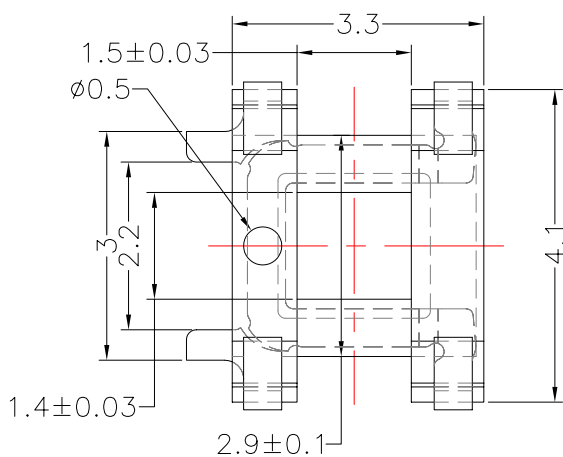
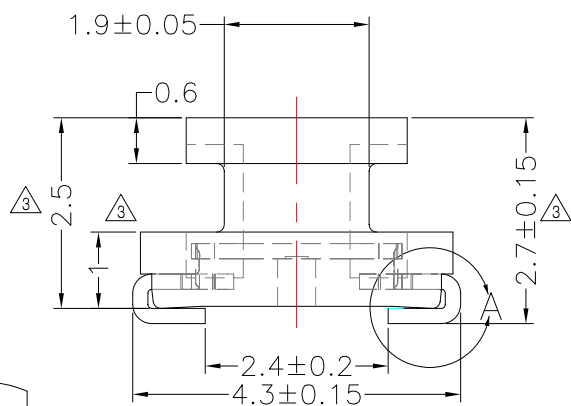
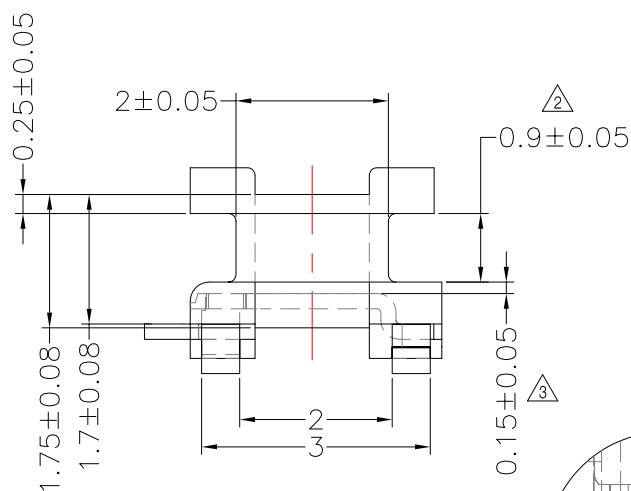
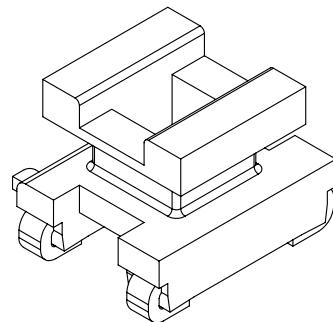
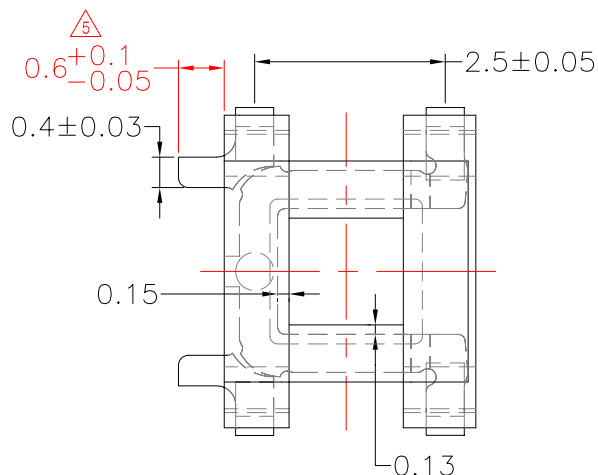


REVISIONS

| REV | SYM | DRAFTER  | CHECKER  | DATE     |
|-----|-----|----------|----------|----------|
| 3   |     | G.F.YANG | W.H.HSU  | 06/01/09 |
| 4   |     | YAN.TANG | G.F.YANG | 10/27/09 |
| 5   |     | G.F.YANG | W.H.HSU  | 02/27/19 |



DWG NO. EEL4.2-4P-C-2.4-G-11

PART NO. MATERIAL (BOBBIN) MATERIAL (TERMINAL) TERMINAL (PLATING) PIN ALLOCATION NOTE

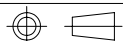
TBI-101-05071.1103

PM-9630

C1100

Sn

ALL PIN



TOLERANCE: .X±0.15 .XX±0.10 .XXX±0.05

UNIT : m / m

SCALE 10 : 1

Finish: 1. PB wire Immersion Sn on terminal : Thickness:Sn plating,100,5 μm (200 μ inches) min,Base nickel 0.625 μm (25 μ inches) min.  
 2. CP wire Immersion Sn on terminal : Thickness:Sn plating,100,5 μm (200 μ inches) min.  
 3. Coplanarity deviation: 0.10 mm (0.004 inches) max.

REV 5